



Product Change Notification

Change Notification #: 116088 - 00
Change Title: Intel® NUC Kit, NUC7CJYH, PCN 116088-00, Product Design, BIOS Update, ID, and support change
Date of Publication: February 12, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 2, 2018
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Description of Change to the Customer:

The Intel® NUC Kit SKU listed in the products affected table below will have the following changes.

1. The BIOS will be updated from JYGLKCPX.86A.0024 to JYGLKCPX.86A.0027. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
2. A resistor is being added for a new board ID/SSID.
3. Change DMIC to support Fortemedia Far-Field AP.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXNUC7CJYH1	961252	J67971-400	J67967-400	J67971-401	J67967-401

PCN Revision History:

Date of Revision: February 12, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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